

# Declaration For Patent Application

I, a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor(if only one name is listed below) or an original, first and joint inventor( if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled Light-emitting Diode Encapsulation Material and Manufacturing Process, the specification of which

(check one)  is attached hereto.

was filed on \_\_\_\_\_ as

Application Serial No. \_\_\_\_\_

and was amended on \_\_\_\_\_  
(if applicable)

I hereby state that I have reviewed and understand the contents of the above identified specification, including the claim(s), as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is material to the examination of this application in accordance with Title 37, Code of Federal Regulations, § 1.56(a).

I hereby claim foreign priority benefits under Title 35, United States Code, § 119 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

## Prior Foreign Application(s)

## Priority Claimed

092123504 (Number)	Taiwan, R.O.C. (Country)	26/August/2003 (Day/Month/Year Filed)	<input checked="" type="checkbox"/> Yes <input type="checkbox"/> No
_____ (Number)	_____ (Country)	_____ (Day/Month/Year Filed)	<input type="checkbox"/> Yes <input type="checkbox"/> No
_____ (Number)	_____ (Country)	_____ (Day/Month/Year Filed)	<input type="checkbox"/> Yes <input type="checkbox"/> No

I hereby claim the benefit under Title 35, United States Code, § 120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, § 112, I acknowledge the duty to disclose material information as defined in Title 37, Code of Federal Regulations, 1.56(a) which occurred between the filing date of the prior application and the national or PCT international filing date of this application:

(Application Serial No.)	(Filing Date)	(Status) (patented, pending, abandoned)
_____ (Application Serial No.)	_____ (Filing Date)	_____ (Status) (patented, pending, abandoned)

And I hereby appoint as principal attorneys

Please direct all communications to the following address:

Yung-Shu YANG  
P.O. Box No. 6-57, Junghe, Taipei 235, Taiwan, R.O.C.

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

All name of sole or first inventor Yung-Shu YANG

Inventor's signature YANG, YUNG-SHU

Residence Jhongshan N. Rd., Shihlin District, Taipei City 111, Taiwan, R.O.C.

Date  
Oct. 1, 2003

Citizenship Taiwan, R.O.C.

Post Office Address P.O. Box No. 6-57, Junghe, Taipei 235, Taiwan, R.O.C.

(Supply similar information and signature for second and subsequent joint inventors.)

Independent Inventor

Attorney's  
Docket No. \_\_\_\_\_

VERIFIED STATEMENT OF SMALL ENTITY STATUS

Honorable Commissioner of Patents and Trademarks  
Washington, D. C. 20231

Sir:

I hereby declare that I am  the sole inventor  a joint inventor of the invention entitled: Light-emitting Diode Encapsulation Material and Manufacturing Process; the invention being described and claimed  in the specification filed herewith,  in the specification of application Serial No. \_\_\_\_\_, filed \_\_\_\_\_ 19\_\_\_\_; and that I have not assigned, granted, conveyed, or licensed, and that I am under no obligation under contract or law to assign, grant, convey, or license, any rights in the invention to any person who could not likewise be classified as an independent inventor if that person had made the invention, or to any concern which would not qualify as a small business concern or a nonprofit organization.

I further declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code, and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

Date: Oct. 1, 2003

YANG, YUNG-SHU

Yung-Shu YANG